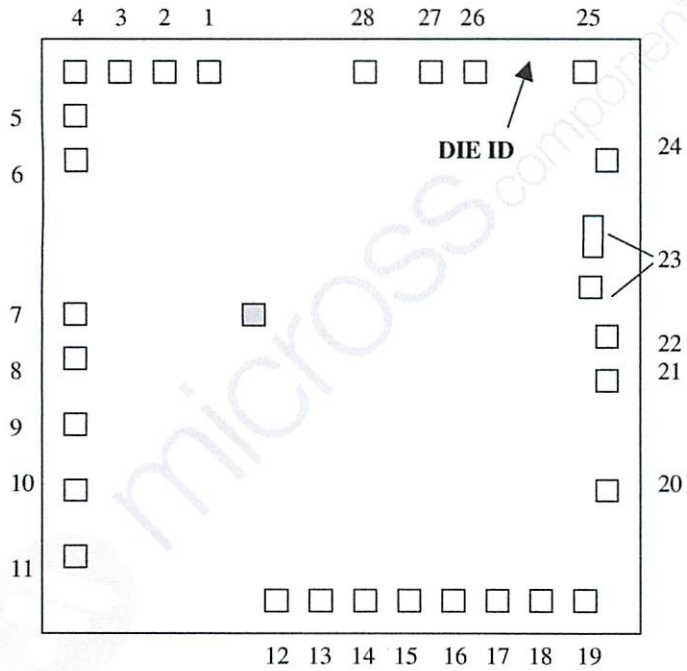
Micross Components Ltd
Unit D2, Meadowbank,
Junction 22 Business Park,
Hollinwood, Oldham, OL9 8EH,
England
Tel: +44(0) 161 683 5236
Fax: +44(0) 161 684 1233
Website: www.micross.com Email: baredie@micross.com



PAD FUNCTIONS

1. +VDD
2. N.WR
3. N.LDAC
4. N.NA
5. N.NB
6. N.NC
7. D11
8. D10
9. D9
10. D8
11. D7
12. D6
13. D5
14. D4
15. DCOM
16. D0
17. D1
18. D2
19. D3
20. +VCC
21. –VCC
22. GAIN ADJ
23. ACOM
24. VOUT
25. 10V RANGE
26. SJ
27. BPO
28. REF OUT

The information given is believed to be correct at the time of issue.
Please verify your requirements prior to commencement of any assembly process, as no liability for omission or error can be accepted.
Back potential is the electrical potential of the substrate (bulk silicon), which may not require an electrical connection unless stated in this drawing.

Note: 1 mil = 0.001inch

APPROVED GB ..... DATE: 19.06.12	DAC811 TEXAS INSTRUMENTS	DIE INFORMATION DIMENSIONS (Mils): 140 x 134 BOND PADS (Mils): MASK REF: GEOMETRY: CIC02394 BACK POTENTIAL:
SERIAL NUMBER. M000782		METALLISATION TOP: Al BACK: Silicon